

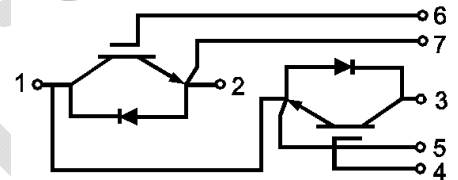
GF300HF120T2VHE

IGBT Module

Preliminary Data

Features:

- Non Punch Through Technology
- Short Circuit Rated >10 μ s
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested (2 \times I_c)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement



Applications:

- Welding Machine/ Cutting Machine
- Induction Heating
- Ultrasonic Device

Maximum Rated Values of IGBT (T_C=25 $^{\circ}$ C unless otherwise specified)

V _{CES}	Collector-Emitter Blocking Voltage		1200	V
V _{GES}	Gate-Emitter Voltage		\pm 20	V
I _C	Continuous Collector Current	T _C = 80 $^{\circ}$ C	300	A
		T _C = 25 $^{\circ}$ C	500	A
I _{CM}	Repetitive Peak Collector Current	T _J = 150 $^{\circ}$ C	600	A
t _{SC}	Short Circuit Withstand Time		>10	μ s
P _D	Maximum Power Dissipation per IGBT	T _C = 25 $^{\circ}$ C T _{Jmax} = 150 $^{\circ}$ C	2150	W

Electrical Characteristics of IGBT ($T_C=25^\circ\text{C}$ unless otherwise specified)

Static Characteristics

Symbol	Description	Conditions	Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C = 3\text{mA}, V_{CE} = V_{GE}$	4.5	5.0	5.5	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 300\text{A}, V_{GE} = 15\text{V}$	$T_J = 25^\circ\text{C}$	3.30	3.50	V
			$T_J = 125^\circ\text{C}$	3.80		V
I_{CES}	Collector-Emitter Leakage Current	$V_{GE} = 0\text{V}, V_{CE} = V_{CES}, T_J = 25^\circ\text{C}$			1	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE} = \pm 20\text{V}, V_{CE} = 0\text{V}, T_J = 25^\circ\text{C}$			400	nA
C_{ies}	Input Capacitance	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$		33.6		nF
C_{oes}	Output Capacitance			2.56		nF

Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	$V_{CC} = 600\text{V}, I_C = 300\text{A}, R_G = 4.7\ \Omega, V_{GE} = \pm 15\text{V},$ Inductive Load	$T_J = 25^\circ\text{C}$	260		ns
			$T_J = 125^\circ\text{C}$	250		
t_r	Rise Time		$T_J = 25^\circ\text{C}$	175		ns
			$T_J = 125^\circ\text{C}$	175		
$t_{d(off)}$	Turn-off Delay Time		$T_J = 25^\circ\text{C}$	740		ns
			$T_J = 125^\circ\text{C}$	775		
t_f	Fall Time		$T_J = 25^\circ\text{C}$	125		ns
			$T_J = 125^\circ\text{C}$	125		
E_{on}	Turn-on Switching Loss		$T_J = 25^\circ\text{C}$	16.4		mJ
			$T_J = 125^\circ\text{C}$	21.0		
E_{off}	Turn-off Switching Loss	$T_J = 25^\circ\text{C}$	20.9		mJ	
		$T_J = 125^\circ\text{C}$	25.4			
Q_g	Total Gate Charge	$T_J = 25^\circ\text{C}$	3600		nC	
RBSOA	Reverse Bias Safe Operation Area	$I_C=600\text{A}, V_{CC}=1050\text{V}, V_p=1200\text{V}, R_g = 4.7\ \Omega, V_{GE}=\pm 15\text{V to } 0\text{V}, T_J = 150^\circ\text{C}$	Trapezoid			
SCSOA	Short Circuit Safe Operation Area	$V_{CC} = 600\text{V}, V_{GE} = 15\text{V}, T_J = 150^\circ\text{C}$	10		μs	
$R_{\theta JC}$	IGBT Thermal Resistance: Junction-To-Case			0.058	$^\circ\text{C/W}$	

Maximum Rated Values of Diode ($T_C=25^\circ\text{C}$ unless otherwise specified)

V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	300	A
I_{FM}	Diode Maximum Forward Current	600	A

Electrical Characteristics of Diode ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Description	Conditions	Min	Typ	Max	Unit
V_{FM}	Forward Voltage	$I_F = 300\text{A}$	$T_J = 25^\circ\text{C}$	2.50		V
			$T_J = 125^\circ\text{C}$	2.70		
I_{rr}	Peak Reverse Recovery Current		$T_J = 25^\circ\text{C}$	145		A
			$T_J = 125^\circ\text{C}$	200		
Q_{rr}	Reverse Recovery Charge	$I_F = 300\text{A}$, $di/dt = 2200\text{A}/\mu\text{s}$, $V_{rr} = 600\text{V}$, $V_{GE} = -15\text{V}$	$T_J = 25^\circ\text{C}$	19.5		μC
			$T_J = 125^\circ\text{C}$	43.6		
E_{rec}	Reverse Recovery Energy		$T_J = 25^\circ\text{C}$	9.8		mJ
			$T_J = 125^\circ\text{C}$	22.0		
$R_{\theta JC}$	Diode Thermal Resistance: Junction-To-Case			0.17		$^\circ\text{C}/\text{W}$

Module

Symbol	Description	Min	Typ	Max	Unit
V_{iso}	Isolation Voltage (All Terminals Shorted)	$f = 50\text{Hz}$, 1minute	2500		V
T_J	Maximum Junction Temperature				
T_{JOP}	Maximum Operating Junction Temperature Range				
T_{stg}	Storage Temperature				
CTI	Comparative Tracking Index				
$R_{\theta CS}$	Case-To-Sink Thermally (Conductive Grease Applied)				
T	Power Terminals Screw:M6	3.0		5.0	N·m
T	Mounting Screw:M6	4.0		6.0	N·m
G	Weight				

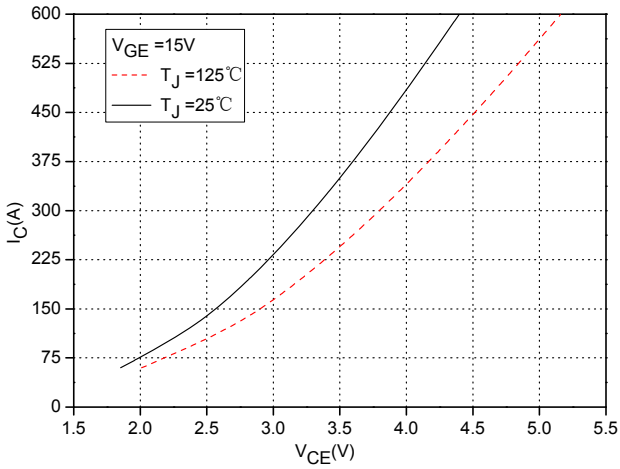


Fig.1 Typical Saturation Voltage Characteristics

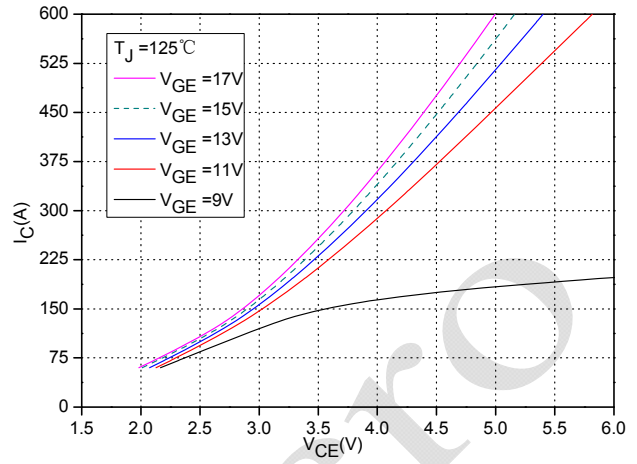


Fig.2 Typical Output Characteristics

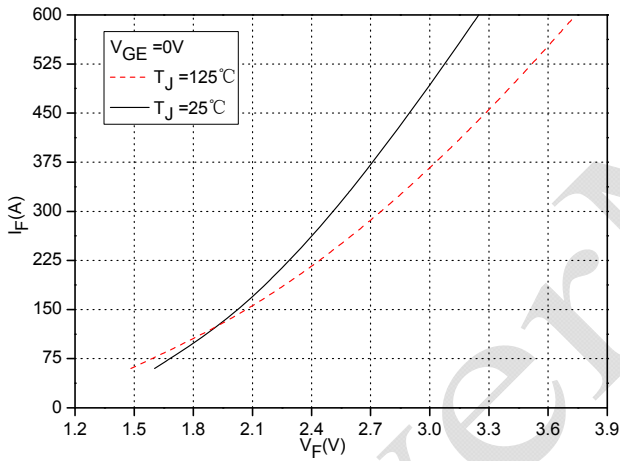


Fig.3 Forward Characteristics of Diode

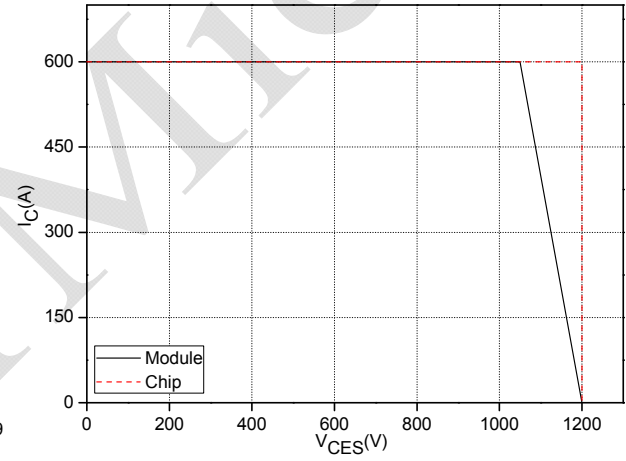


Fig.4 Reverse Bias Safe Operation Area (RBSOA)

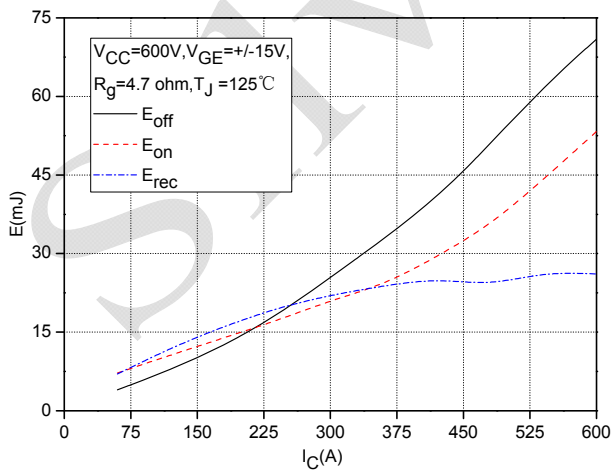


Fig.5 Typical Switching Loss vs. Collector Current

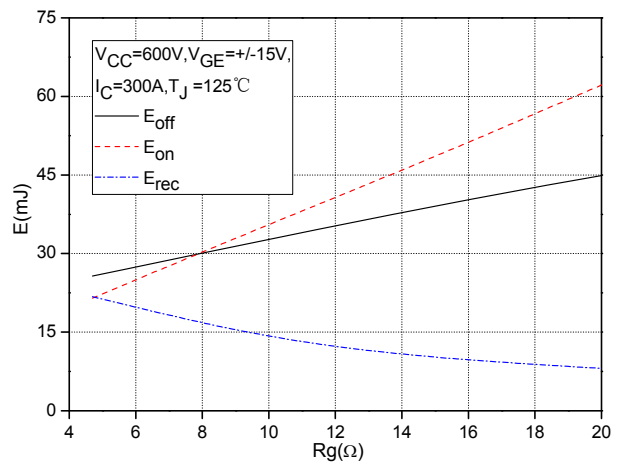


Fig.6 Typical Switching Loss vs. Gate Resistance

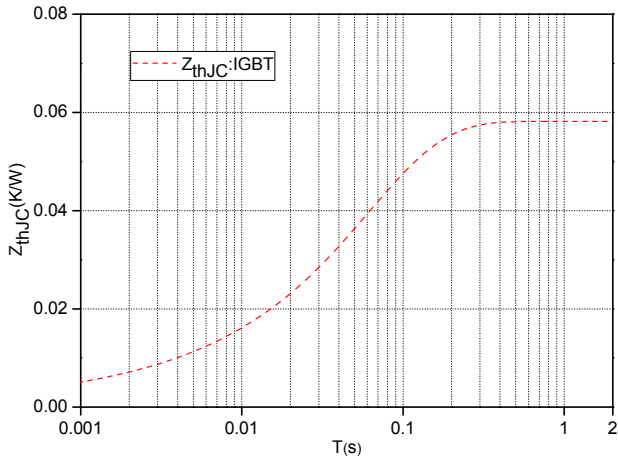


Fig. 7 Transient Thermal Impedance (IGBT)

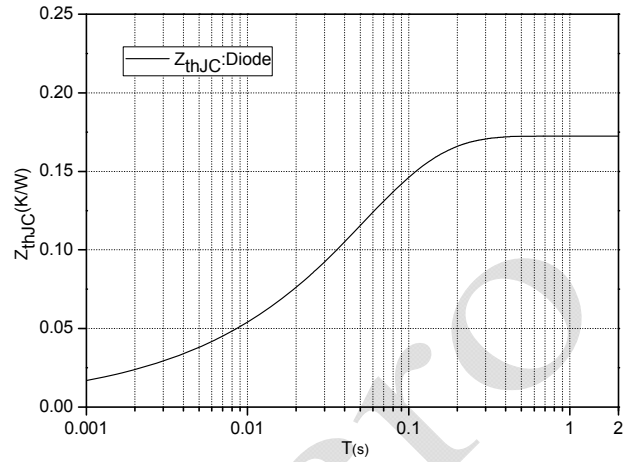


Fig. 8 Transient Thermal Impedance (Diode)

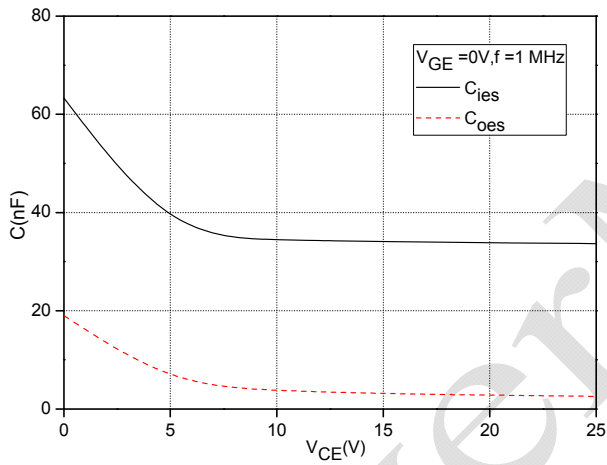
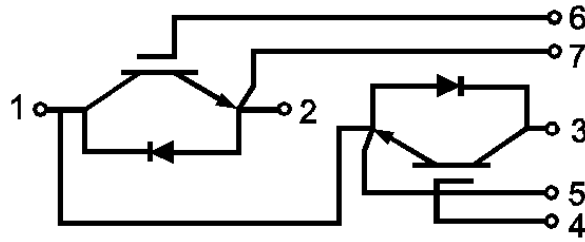
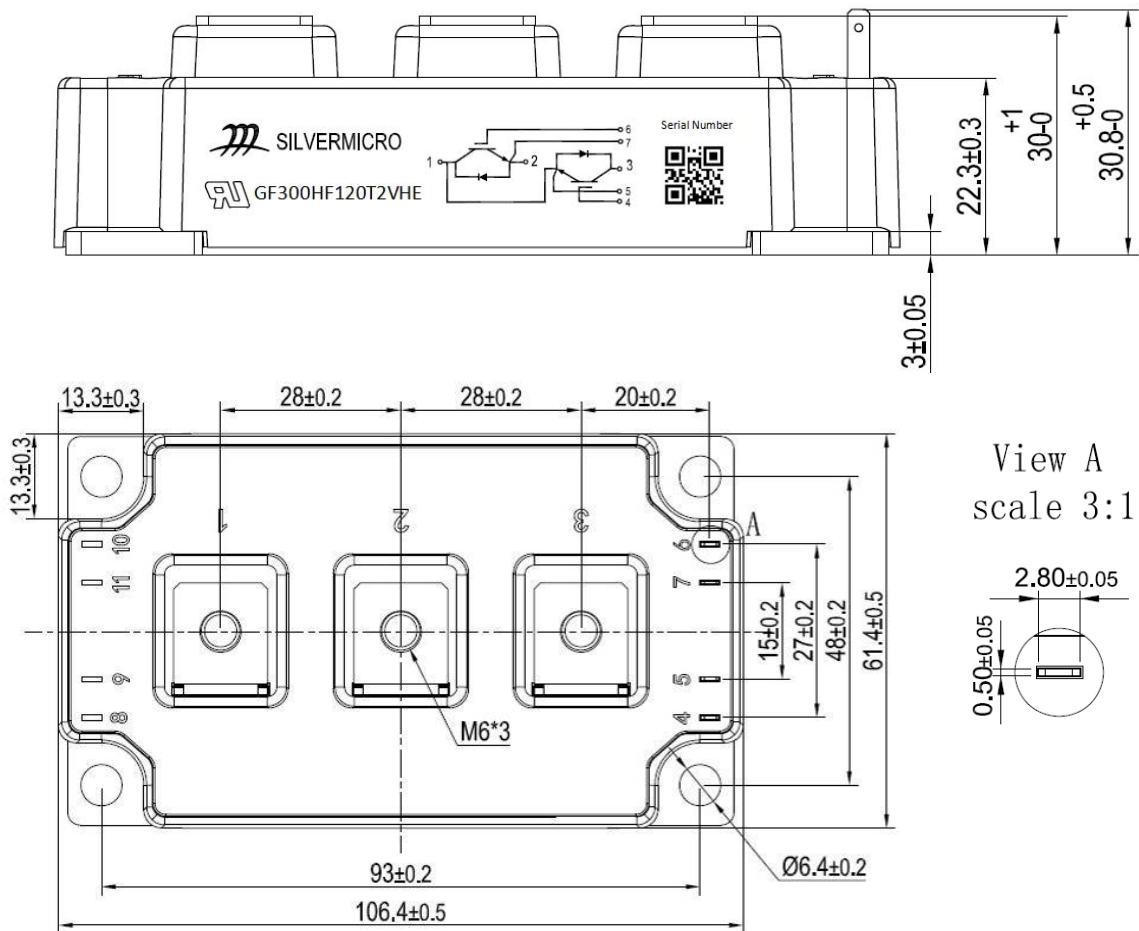


Fig. 9 Capacitance Characteristics

Internal Circuit



Package Outline (Unit: mm):





Announcement

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